

ACF-2 I型3-电平NPC 逆变模块

ACF-2 I Type 3-Level NPC Inverter Module

特性/Features:

- I型NPC三电平逆变模块
I type NPC Three-Level Inverter Module
- 650V 沟槽栅/场截止工艺
650V Trench Gate/Field-Stop Process
- 内置直流电容
Integrated DC capacitor
- 低 V_{CEsat} /低开关损耗
Low V_{CEsat} / Low Switching Losses
- V_{CEsat} 正温度系数
 V_{CEsat} with Positive Temperature Coefficient
- 低热阻三氧化二铝 (Al_2O_3) 衬底
 Al_2O_3 Substrate with Low Thermal Resistance
- 紧凑型&低电感设计
Compact and low inductance Design
- 采用DBC技术的隔离散热器
Isolated Heatsink using DBC technology



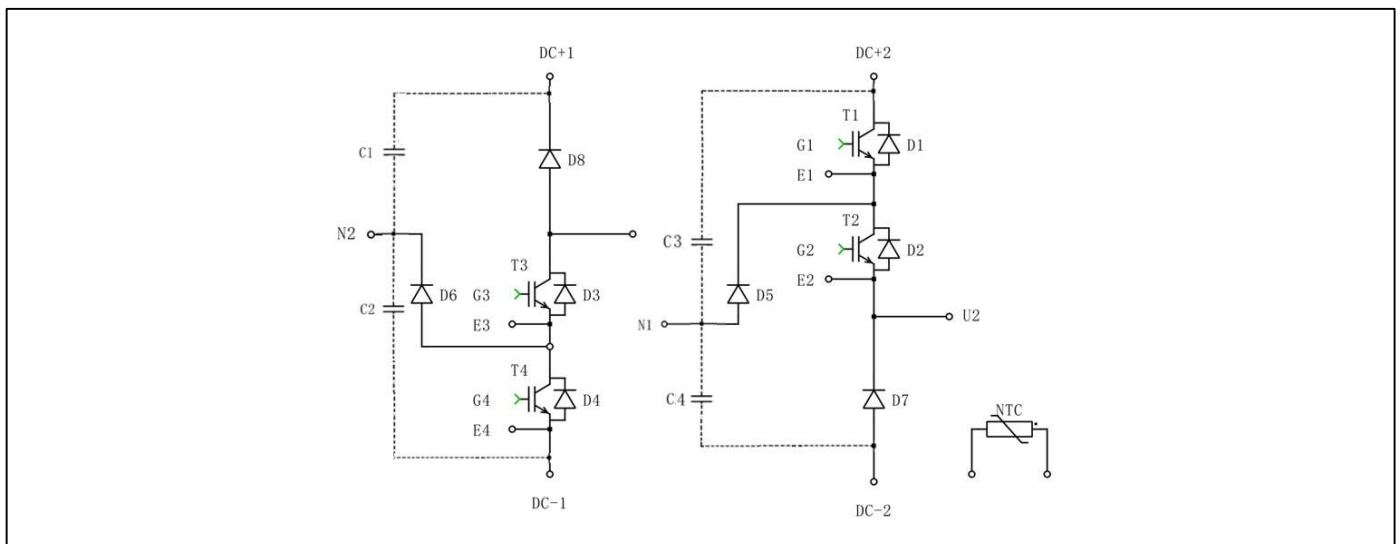
12mm or 13mm Housing

Marking Diagram

AMG300L65F2S5RA = Specific Device
F2CQ22420010001 = Lot Traceability
ACF-2 = Package Type

应用/Application:S

- 不间断电源/UPS Systems
- 太阳能系统/Solar Applications
- 工业驱动器/Industrial Drives



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1 封装/Package

表 1 绝缘参数/Insulation coordination

Parameter	Conditions	Symbol	Value		Unit
			Min.	Typ.	
绝缘测试电压 Isolation test voltage	RMS, f = 50Hz, t = 3s	V _{ISO}	3.0		kV
内部绝缘 Internal isolation	基本绝缘 (class 1, IEC 61140) Basic insulation (class 1, IEC 61140)		Al ₂ O ₃		
爬电距离 Creepage distance	端子至散热器 Terminal to heatsink	d _{Creep}	>12.7		mm
电气间隙 Clearance	端子至散热器 Terminal to heatsink	d _{Clear}	>12.7		mm
相对电痕指数 Comparative tracking index		CTI	≥600		

表 2 特征值/Characteristic values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
杂散电感, 模块 Stray inductance module		L _{sCE}		20		nH
储存温度 Storage temperature		T _{stg}	-40		125	°C
工作温度 Operation temperature under switching condition		T _{vjop}	-40		T _{jmax} -25	°C
端子安装扭距 (参考安装指导说明) Terminal connection torque	根据相应的应用手册进行安装 Mounting according to valid application note	M5, 螺丝 M5, Screw	1.5		6.0	N.m
重量 Weight		G		175		g

2 IGBT (T1/T4)

表 3 最大标定值/Maximum rated values

Parameter	Conditions		Symbol	Value	Unit
集电极-发射极电压 Collector-emitter voltage		$T_j = 25^\circ\text{C}$	V_{CES}	650	V
连续集电极直流电流 Continuous DC collector current	$T_{j\max} = 175^\circ\text{C}$	$T_h = 80^\circ\text{C}$	I_{CDC}	270	A
集电极重复峰值电流 Repetitive peak collector current	t_p limited by $T_{j\max}$		I_{CRM}	900	A
总耗散功率 Total Power dissipation	$T_j = T_{j\max}, T_h = 80^\circ\text{C}$		P_{tot}	432	W
栅极-发射极电压 Gate-emitter peak voltage			V_{GES}	± 20	V

表 4 特征值/Characteristic values

Parameter	Conditions	Symbol	Value			Unit	
			Min.	Typ.	Max.		
集电极-发射极饱和电压 (端对端) Collector-emitter saturation voltage (pin to pin)	$I_C = 300\text{A}, V_{GE} = 15\text{V}$	$T_j = 25^\circ\text{C}$		1.47		V	
		$T_j = 125^\circ\text{C}$		1.58			
栅极阈值电压 Gate threshold voltage	$I_C = 3\text{mA}, V_{GE} = V_{CE}, T_j = 25^\circ\text{C}$	V_{Geth}		4.0		V	
栅极电荷 Gate charge	$V_{GE} = \pm 15\text{V}, V_{CE} = 400\text{V}, I_C = 300\text{A}$	Q_G		780		nC	
输入电容 Input capacitance	$f = 1\text{MHz}, T_j = 25^\circ\text{C}, V_{CE} = 20\text{V}, V_{GE} = 0\text{V}$	C_{ies}		32000		pF	
输出电容 Output capacitance		C_{oes}		920		pF	
反向传输电容 Reverse transfer capacitance		C_{res}		24		pF	
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE} = 650\text{V}, V_{GE} = 0\text{V}, T_j = 25^\circ\text{C}$	I_{CES}			100	μA	
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_j = 25^\circ\text{C}$	I_{GES}			200	nA	
开通延迟时间 (感性负载) Turn-on delay time (inductive load)	$V_{CC} = 400\text{V}, I_C = 150\text{A}$ $V_{GE} = +15/-5\text{V}, R_{gon} = R_{goff} = 12\Omega$	$T_j = 25^\circ\text{C}$	tdon		154	ns	
		$T_j = 125^\circ\text{C}$			144		
上升时间 (感性负载) Rise time (inductive load)		$T_j = 25^\circ\text{C}$	tr		68	ns	
		$T_j = 125^\circ\text{C}$			75		
关断延迟时间 (感性负载) Turn-off delay time (inductive load)		$T_j = 25^\circ\text{C}$	tdoff		847	nS	
		$T_j = 125^\circ\text{C}$			916		
下降时间 (感性负载) Fall time (inductive load)		$T_j = 25^\circ\text{C}$	tf		87	nS	
		$T_j = 125^\circ\text{C}$			72		
开通损耗能量 (每脉冲) Turn-on energy loss per pulse		$T_j = 25^\circ\text{C}$	Eon		5.64	mJ	
		$T_j = 125^\circ\text{C}$			7.77		
关断损耗能量 (每脉冲) Turn-off energy loss per pulse		$T_j = 25^\circ\text{C}$	Eoff		4.61	mJ	
		$T_j = 125^\circ\text{C}$			5.54		
结-散热器热阻 Thermal resistance, junction to heatsink		每个IGBT, $\lambda_{grease} = 3.4\text{W}/(\text{m}^*\text{K})$ Per IGBT, $\lambda_{grease} = 3.4\text{W}/(\text{m}^*\text{K})$	R_{thJH}		0.22		K/W
最高结温 Maximum junction temperature			T_{jop}		175		$^\circ\text{C}$

3 Diode (D5/D6)

表 5 最大标定值/Maximum rated values

Parameter	Conditions		Symbol	Value		Unit
反向重复峰值电压 Repetitive peak reverse voltage		$T_j = 25^\circ\text{C}$	V_{RRM}	650		V
连续正向直流电流 Continuous DC forward current	$T_{j\max} = 175^\circ\text{C}$	$T_h = 80^\circ\text{C}$	I_F	255		A
正向重复峰值电流 Repetitive peak forward current	t_p limited by $T_{j\max}$		I_{FRM}	600		A
总耗散功率 Total Power dissipation	$T_j = T_{j\max}, T_h = 80^\circ\text{C}$		P_{tot}	317		W

表 6 特征值/Characteristic values

Parameter	Conditions		Symbol	Value			Unit
				Min.	Typ.	Max.	
正向电压 Forward voltage	$I_F = 300\text{A}, V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$	V_F		1.62		V
		$T_j = 125^\circ\text{C}$			1.53		
反向恢复峰值电流 Peak reverse recovery current	$V_R = 400\text{V}, I_F = 150\text{A},$	$T_j = 25^\circ\text{C}$	I_{rm}		35		A
		$T_j = 125^\circ\text{C}$			72		
反向恢复时间 Reverse recovery time		$T_j = 25^\circ\text{C}$	T_{rr}		142		nS
		$T_j = 125^\circ\text{C}$			190		
反向恢复电荷 Recovered charge		$T_j = 25^\circ\text{C}$	Q_r		2.3		μC
		$T_j = 125^\circ\text{C}$			7.6		
反向恢复损耗（每脉冲） Reverse recovery energy	$T_j = 25^\circ\text{C}$	E_{rec}		0.41		mJ	
	$T_j = 125^\circ\text{C}$			1.72			
结—散热器热阻 Thermal resistance, junction to heatsink	每个二极管, $\lambda_{grease} = 3.4 \text{ W}/(\text{m}^*\text{K})$ Per diode, $\lambda_{grease} = 3.4 \text{ W}/(\text{m}^*\text{K})$		R_{thCH}		0.3		K/W
最高结温 Maximum junction temperature			$T_{j\text{op}}$		175		$^\circ\text{C}$

4 Diode (D1/D2/D3/D4)

表 7 最大标定值/Maximum rated values

Parameter	Conditions		Symbol	Value		Unit
反向重复峰值电压 Repetitive peak reverse voltage		$T_j = 25^\circ\text{C}$	V_{RRM}	650		V
连续正向直流电流 Continuous DC forward current	$T_{j\max} = 175^\circ\text{C}$	$T_h = 80^\circ\text{C}$	I_F	50		A
正向重复峰值电流 Repetitive peak forward current	t_p limited by $T_{j\max}$		I_{FRM}	150		A
总耗散功率 Total Power dissipation	$T_j = T_{j\max}, T_h = 80^\circ\text{C}$		P_{tot}	79		W

表 8 特征值/Characteristic values

Parameter	Conditions		Symbol	Value			Unit
				Min.	Typ.	Max.	
正向电压 Forward voltage	$I_F = 50\text{A}, V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$	V_F		1.75		V
		$T_j = 125^\circ\text{C}$			1.61		
结—散热器热阻 Thermal resistance, junction to heatsink	每个二极管, $\lambda_{grease} = 3.4 \text{ W}/(\text{m}^*\text{K})$ Per diode, $\lambda_{grease} = 3.4 \text{ W}/(\text{m}^*\text{K})$		R_{thCH}		1.2		K/W
最高结温 Maximum junction temperatur			$T_{j\text{op}}$		175		$^\circ\text{C}$

5 IGBT (T2/T3)

表 9 最大标定值/Maximum rated values

Parameter	Conditions		Symbol	Value	Unit
集电极-发射极电压 Collector-emitter voltage		$T_j = 25^\circ\text{C}$	V_{CES}	650	V
连续集电极直流电流 Continuous DC collector current	$T_{j\max} = 175^\circ\text{C}$	$T_h = 80^\circ\text{C}$	I_{CDC}	270	A
集电极重复峰值电流 Repetitive peak collector current	t_p limited by $T_{j\max}$		I_{CRM}	900	A
总耗散功率 Total Power dissipation	$T_j = T_{j\max}, T_h = 80^\circ\text{C}$		P_{tot}	432	W
栅极-发射极电压 Gate-emitter peak voltage			V_{GES}	± 20	V

表 10 特征值/Characteristic values

Parameter	Conditions		Symbol	Value			Unit		
				Min.	Typ.	Max.			
集电极-发射极饱和电压 (端对端) Collector-emitter saturation voltage (pin to pin)	$I_C = 300\text{A}, V_{GE} = 15\text{V}$	$T_j = 25^\circ\text{C}$	$V_{CE\text{ sat}}$		1.47		V		
		$T_j = 125^\circ\text{C}$			1.52				
栅极阈值电压 Gate threshold voltage	$I_C = 3\text{ mA}, V_{GE} = V_{CE}, T_j = 25^\circ\text{C}$		V_{GEth}		4.0		V		
栅极电荷 Gate charge	$V_{GE} = \pm 15\text{ V}, V_{CE} = 400\text{V}$		Q_G		780		nC		
输入电容 Input capacitance	$f = 1\text{MHz}, T_j = 25^\circ\text{C}, V_{CE} = 20\text{V}, V_{GE} = 0\text{V}$		C_{ies}		32000		pF		
输出电容 Output capacitance			C_{oes}		920		pF		
反向传输电容 Reverse transfer capacitance			C_{res}		24		pF		
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE} = 650\text{V}, V_{GE} = 0\text{V}, T_j = 25^\circ\text{C}$		I_{CES}			100	μA		
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_j = 25^\circ\text{C}$		I_{GES}			200	nA		
开通延迟时间 (感性负载) Turn-on delay time (inductive load)	$V_{CC} = 400\text{ V}, I_C = 150\text{A}$ $V_{GE} = +15/-5\text{ V}, R_{gon} = R_{goff} = 12\ \Omega$		t_{don}	$T_j = 25^\circ\text{C}$		121	ns		
				$T_j = 125^\circ\text{C}$		115			
上升时间 (感性负载) Rise time (inductive load)			t_r	$T_j = 25^\circ\text{C}$		69	ns		
				$T_j = 125^\circ\text{C}$		74			
关断延迟时间 (感性负载) Turn-off delay time (inductive load)			t_{doff}	$T_j = 25^\circ\text{C}$		865	nS		
				$T_j = 125^\circ\text{C}$		951			
下降时间 (感性负载) Fall time (inductive load)			t_f	$T_j = 25^\circ\text{C}$		92	nS		
				$T_j = 125^\circ\text{C}$		75			
开通损耗能量 (每脉冲) Turn-on energy loss per pulse			E_{on}	$T_j = 25^\circ\text{C}$		5.01	mJ		
				$T_j = 125^\circ\text{C}$		7.62			
关断损耗能量 (每脉冲) Turn-off energy loss per pulse			E_{off}	$T_j = 25^\circ\text{C}$		5.16	mJ		
				$T_j = 125^\circ\text{C}$		6.10			
结-散热器热阻 Thermal resistance, junction to heatsink			每个IGBT, $\lambda_{grease} = 3.4\text{W}/(\text{m}^*\text{K})$ Per IGBT, $\lambda_{grease} = 3.4\text{W}/(\text{m}^*\text{K})$		R_{thJH}		0.22		K/W
最高结温 Maximum junction temperature					T_{jop}		175		$^\circ\text{C}$

6 Diode (D7/D8)

表 11 最大标定值/Maximum rated values

Parameter	Conditions		Symbol	Value		Unit
反向重复峰值电压 Repetitive peak reverse voltage		$T_j = 25^\circ\text{C}$	V_{RRM}	1200		V
连续正向直流电流 Continuous DC forward current	$T_{j\max} = 175^\circ\text{C}$	$T_h = 80^\circ\text{C}$	I_F	240		A
正向重复峰值电流 Repetitive peak forward current	t_p limited by $T_{j\max}$		I_{FRM}	600		A
总耗散功率 Total Power dissipation	$T_j = T_{j\max}, T_h = 80^\circ\text{C}$		P_{tot}	475		W

表 12 特征值/Characteristic values

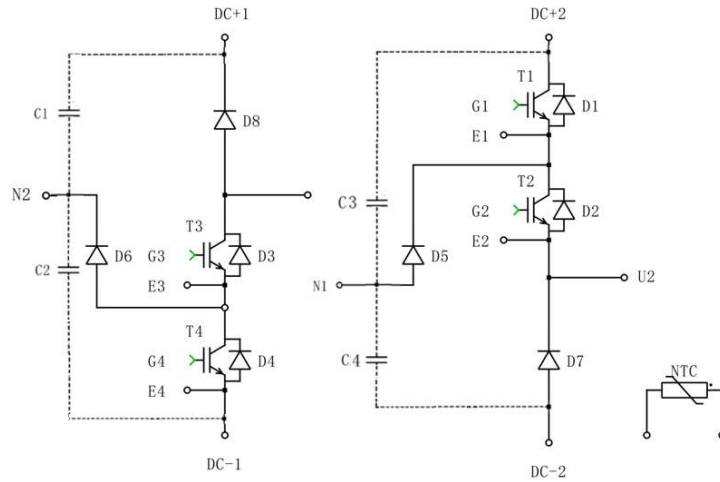
Parameter	Conditions		Symbol	Value			Unit
				Min.	Typ.	Max.	
正向电压 Forward voltage	$I_F = 300\text{A}, V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$	V_F		2.3		V
		$T_j = 125^\circ\text{C}$			2.2		
反向恢复峰值电流 Peak reverse recovery current	$V_R = 400\text{V}, I_F = 150\text{A},$	$T_j = 25^\circ\text{C}$	I_{RM}		29		A
		$T_j = 125^\circ\text{C}$			60		
反向恢复时间 Reverse recovery time		$T_j = 25^\circ\text{C}$	T_{rr}		105		nS
		$T_j = 125^\circ\text{C}$			128		
反向恢复电荷 Recovered charge		$T_j = 25^\circ\text{C}$	Q_r		2.1		μC
		$T_j = 125^\circ\text{C}$			6.4		
反向恢复损耗（每脉冲） Reverse recovery energy		$T_j = 25^\circ\text{C}$	E_{rec}		1.15		mJ
		$T_j = 125^\circ\text{C}$			2.23		
结-散热器热阻 Thermal resistance, junction to heatsink	每个二极管, $\lambda_{grease} = 3.4 \text{ W}/(\text{m}^*\text{K})$ Per diode, $\lambda_{grease} = 3.4 \text{ W}/(\text{m}^*\text{K})$		R_{thCH}	0.2		K/W	
最高结温 Maximum junction temperature			$T_{j\text{op}}$	175		$^\circ\text{C}$	

7 负温度系数热敏电阻/NTC-Thermistor

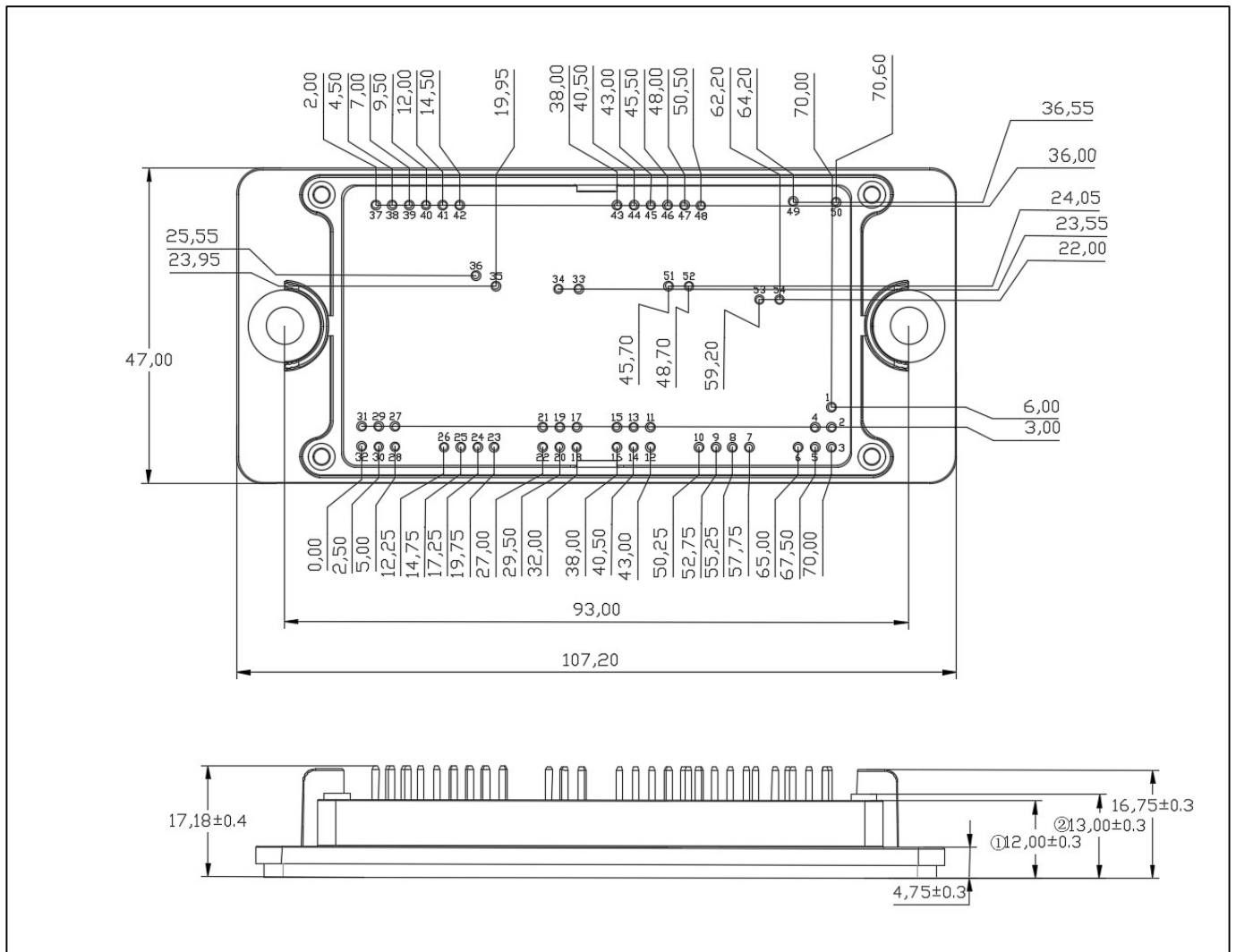
表 13 特征值/Characteristic values

Parameter	Conditions		Symbol	Value			Unit
				Min.	Typ.	Max.	
额定电阻值 Rated resistance	$T_{NTC} = 25^\circ\text{C}$		R_{25}		22		k Ω
R_{100} 偏差 Deviation of R_{100}	$T_{NTC} = 100^\circ\text{C}, R_{100} = 1486 \Omega$		$\Delta R/R$	-5		5	%
耗散功率 Power dissipation	$T_{NTC} = 25^\circ\text{C}$		P_{25}			200	mW
B-值 B-value	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		$B_{25/50}$		3950		K

8 电路拓扑图 / Circuit diagram



9 封装尺寸 / Package outlines



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